



# Product Change Notification

## 108150 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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# Product Change Notification

**Change Notification #:** 108150 - 01  
**Change Title:** Intel(R) IP Network Server, PCN 108150-01, Product Design, Remove gasket from IO filler assembly, Reason for Revision: Post TA Revisions  
**Date of Publication:** June 27, 2008

## Key Characteristics of the Change:

Product Design

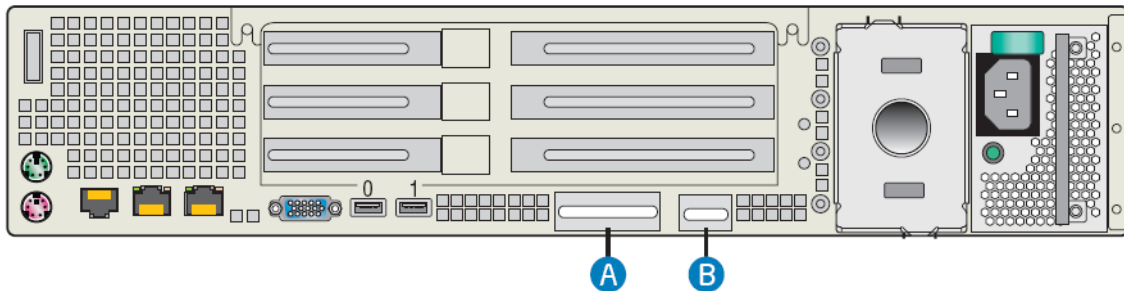
## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Mar 21, 2008
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## Description of Change to the Customer:

### Reason for Revision: Post TA Revisions

We removed the gaskets from the option module fillers (labeled "A" & "B" below) because the gasket is not required to pass the EMI scan. The gasket was located on the bottom surface of the stainless steel filler.



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## Customer Impact of Change and Recommended Action:

There is no anticipated impact to the customer. The recommendation is to use the gasketed or non-gasketed option fillers as shipped on the chassis.

## Products Affected / Intel Ordering Codes:

Pre Change Product Code	Pre Change MM#	Pre Change TA	Post Change TA
NSCD0201W	889357	D86178-010	D86178-010
NCSA0201W	889358	D86176-010	D86176-010

## **PCN Revision History:**

**Date of Revision:**

December 21, 2007

June 27, 2008

**Revision Number:**

00

01

**Reason:**

Originally Published PCN

Post TA Revisions